

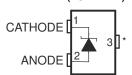
LM4041 Precision Micropower Shunt Voltage Reference

1 Features

- 1.225-V Fixed and Adjustable Outputs (1.225 V to 10 V)
- Tight Output Tolerances and Low Temperature Coefficient
 - Max 0.1%, 100 ppm/°C A Grade
 - Max 0.2%, 100 ppm/°C B Grade
 - Max 0.5%, 100 ppm/°C C Grade
 - Max 1.0%, 150 ppm/°C D Grade
- Low Output Noise . . . 20 μV_{RMS} (Typ)
- Wide Operating Current Range . . . 45 µA (Typ) to 12 mA
- Stable With All Capacitive Loads; No Output Capacitor Required
- Available in
 - Industrial Temperature: –40°C to 85°C
 - Extended Temperature: –40°C to 125°C

2 Applications

- **Data-Acquisition Systems**
- Power Supplies and Power-Supply Monitors
- Instrumentation and Test Equipment
- **Process Control**
- Precision Audio
- **Automotive Electronics**
- **Energy Management/Metering**
- **Battery-Powered Equipment** 1.2 V . . . DBZ (SOT-23) PACKAGE (TOP VIEW)



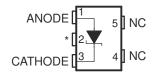
* Pin 3 must be connected to ANODE or left open.

3 Description

The LM4041 series of shunt voltage references are versatile, easy-to-use references suitable for a wide array of applications. They require no external capacitors for operation and are stable with all capacitive loads. Additionally, the reference offers low dynamic impedance, low noise, and a low temperature coefficient to ensure a stable output voltage over a wide range of operating currents and temperatures. The LM4041 uses fuse and Zener-zap reverse breakdown voltage trim during wafer sort to offer four output voltage tolerances, ranging from 0.1% (max) for the A grade to 1% (max) for the D grade. Thus, a great deal of flexibility is offered to designers in choosing the best cost-to-performance ratio for their applications. The LM4041 is available in a fixed (1.225 V nominal) or an adjustable version (which requires an external resistor divider to set the output to a value between 1.225 V and 10 V).

Packaged in space-saving SC-70 and SOT-23-3 and requiring a minimum current of 45 µA (typ), the LM4041 also is ideal for portable applications. The TO-92 package also is available for through-hole packaging needs. The LM4041xI is characterized for operation over an ambient temperature range of -40°C to 85°C. The LM4041xQ is characterized for operation over an ambient temperature range of -40°C to 125°C.

1.2 V . . . DCK (SC-70) PACKAGE (TOP VIEW)



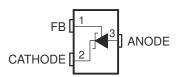
NC - No internal connection * Pin 2 must be connected to ANODE or left open.

1.2 V . . . LP (TO-92/TO-226) PACKAGE (TOP VIEW)

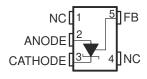


NC - No internal connection

Adjustable . . . DBZ (SOT-23) PACKAGE (TOP VIEW)

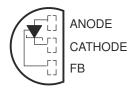


Adjustable...DCK (SC-70) PACKAGE (TOP VIEW)



NC - No internal connection

Adjustable . . . LP (TO-92/TO-226) PACKAGE (TOP VIEW)





4 Functional Block Diagram

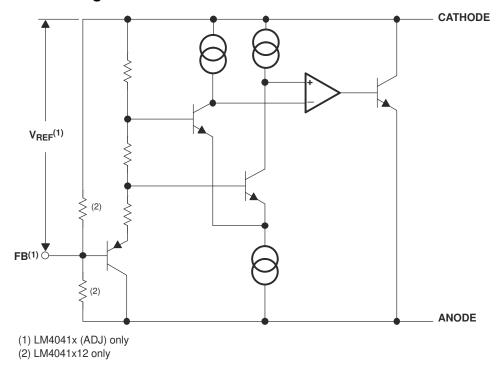


Figure 4-1. Functional Block Diagram

5 Absolute Maximum Ratings

over free-air temperature range (unless otherwise noted)

			MIN	MAX (1)	UNIT
Vz	Continuous cathode voltage			15	V
IZ	Continuous cathode current		-10	25	mA
		DBZ package		206	
θ_{JA}	Package thermal impedance ^{(2) (3)}	DCK package		252	°C/W
		LP package		156	
TJ	Operating virtual junction temperature	·		150	°C
T _{stg}	Storage temperature range		-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

6 Recommended Operating Conditions

			MIN	MAX	UNIT
IZ	Cathode current		(1)	12	mA
Vz	Reverse breakdown voltage (adjustable version)			10	V
_	Free air temperature	LM4041 (I temperature)	-40	85	°C
I'A	Free-air temperature	LM4041 (Q temperature)	-40	125	C

⁽¹⁾ See parametric tables

7 LM4041x12I Electrical Characteristics

full-range $T_{\Delta} = -40^{\circ}$ C to 85°C (unless otherwise noted)

	DADAMETED	TEST CONDITIONS	т.	LM	4041A12	:I	LM	4041B12	1	UNIT	
	PARAMETER	1EST CONDITIONS	T _A	MIN	TYP	MAX	MIN	TYP	MAX	UNII	
Vz	Reverse breakdown voltage	I _Z = 100 μA	25°C		1.225			1.225		V	
	Reverse breakdown	L = 100 · · A	25°C	-1.2		1.2	-2.4		2.4	m)/	
	voltage tolerance	I _Z = 100 μA	Full range	-9.2		9.2	-10.4		10.4	IIIV	
	Minimum cathode		25°C		45	75		45	75		
I _{Z,min}	current		Full range			80			80	μΑ	
		I _Z = 10 mA	25°C		±20			±20			
_	Average temperature coefficient of reverse	I ₇ = 1 mA	25°C		±15			±15			
α_{VZ}	breakdown voltage	IZ - I IIIA	Full range			±100			±100		
		Ι _Ζ = 100 μΑ	25°C		±15			±15			
		I _{Z,min} < I _Z < 1 mA	25°C		0.7	1.5		0.7	1.5		
$\Delta V_7/\Delta I_7$	Reverse breakdown voltage change with	12,min > 12 > 1 11174	Full range			2			2	mV μA	
A V Z/AIZ	cathode current change	1 mA < I ₇ < 12 mA	25°C		4	6		4	6	IIIV	
		1 111A < 12 < 12 11IA	Full range			8			8		
Z _Z	Reverse dynamic impedance	$I_Z = 1 \text{ mA, } f = 120 \text{ Hz,}$ $I_{AC} = 0.1 I_Z$	25°C		0.5	1.5		0.5	1.5	Ω	
e _N	Wideband noise	I _Z = 100 μA, 10 Hz ≤ f ≤ 10 kHz	25°C		20			20		μV_{RMS}	
	Long-term stability of reverse breakdown voltage	t = 1000 h, T _A = 25°C ± 0.1°C, I _Z = 100 μA	25°C		120			120		ppm	



8 LM4041x12I Electrical Characteristics

full-range $T_A = -40$ °C to 85°C (unless otherwise noted)

	DADAMETED	TEST CONDITIONS	_	LM	4041C12	:I	LM	4041D12	ı I	LINUT
	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	MIN	TYP	MAX	UNII
V _Z	Reverse breakdown voltage	I _Z = 100 μA	25°C		1.225			1.225		V
	Reverse breakdown	L = 100 uA	25°C	-6		6	-12		12	m\/
	voltage tolerance	I _Z = 100 μA	Full range	-14		14	-24		24	UNIT V mV μA ppm/°C mV Ω μV _{RMS} ppm
	Minimum cathode		25°C		45	75		45	75	24 75 30 μΑ 50 ppm/°C
I _{Z,min}	current		Full range			80			80	μΑ
		I _Z = 10 mA	25°C		±20			±20		
a	Average temperature coefficient of reverse	I _Z = 1 mA	25°C		±15			±15		nnm/°C
α_{VZ}	breakdown voltage	IZ - I IIIA	Full range			±100			±150	ppin/ C
		Ι _Ζ = 100 μΑ	25°C		±15			±15		
		I _{Z,min} < I _Z < 1 mA	25°C		0.7	1.5		0.7		
۸۱/_/۸۱_	Reverse breakdown voltage change with	IZ,min > IZ > I IIIA	Full range			2			2.5	mV μA ppm/°C mV Ω μV _{RMS}
A V Z/ AIZ	cathode current change	1 mA < I ₇ < 12 mA	25°C		2.5	6		2.5	8	IIIV
		1 111A \ 1Z \ 12 111A	Full range			8			10	
Z _Z	Reverse dynamic impedance	I _Z = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _Z	25°C		0.5	1.5		0.5	2	Ω
e _N	Wideband noise	I _Z = 100 μA, 10 Hz ≤ f ≤ 10 kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T _A = 25°C ± 0.1°C, I _Z = 100 μA	25°C		120			120		ppm

9 LM4041x12Q Electrical Characteristics

full-range $T_A = -40$ °C to 125°C (unless otherwise noted)

	DADAMETED	TEGT CONDITIONS	-	LM	4041C12	Q	LM	4041D12	Q	
	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	MIN	TYP	MAX	UNII
Vz	Reverse breakdown voltage	I _Z = 100 μA	25°C		1.225			1.225		V
	Reverse breakdown	I _Z = 100 μA	25°C	-6		6	-12		12	m\/
	voltage tolerance	12 - 100 μΑ	Full range	-18.4		18.4	-31		31	IIIV
1	Minimum cathode		25°C		45	75		45	75	mV μA ppm/°C
I _{Z,min}	current		Full range			80			80	μΛ
		I _Z = 10 mA	25°C		±20			±20		
G	Average temperature coefficient of reverse	I _Z = 1 mA	25°C		±15			±15		ppm/°C
α_{VZ}	breakdown voltage	IZ - I IIIA	Full range			±100			±150	
		Ι _Ζ = 100 μΑ	25°C		±15			±15		
		1	25°C		0.7	1.5		0.7	5 7 2	
$\Delta V_7/\Delta I_7$	Reverse breakdown	$I_{Z,min} < I_Z < 1 \text{ mA}$	Full range			2			2.5	m\/
ΔνζιΔιζ	voltage change with cathode current change	1 mA < I ₇ < 12 mA	25°C		2.5	6		2.5	8	IIIV
		T IIIA < IZ < IZ IIIA	Full range			8			10	
7	Reverse dynamic	I _Z = 1 mA, f = 120 Hz,	25°C		0.5			0.5		0
Z_Z	impedance	$I_{AC} = 0.1 I_Z$	Full range			1.5			2	22
e _N	Wideband noise	I _Z = 100 μA, 10 Hz ≤ f ≤ 10 kHz	25°C		20			20		μV _{RMS}
		25°C		120			120		ppm	



10 LM4041xl (Adjustable Version) Electrical Characteristics

full-range $T_A = -40$ °C to 85°C (unless otherwise noted)

6	ADAMETED	TEST CONDITIONS	_	L	LM4041BI LM4041CI					LINUT
Ρ.	ARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V _{REF}	Reference voltage	I _Z = 100 μA, V _Z = 5 V	25°C		1.233			1.233		V
	Reference voltage	I ₇ = 100 μA, V ₇ = 5 V	25°C	-2.5		2.5	-6.2		6.2	m)/
	tolerance ⁽¹⁾	$I_Z = 100 \mu A, V_Z = 3 V$	Full range	-10.5		10.5	-14		14	1111
	Minimum cathode		25°C		45	75		45	75	
I _{Z,min}	current		Full range			80			80	μA
		I _{Z,min} < I _Z < 1 mA	25°C		0.7	1.5		0.7	1.5	
$\Delta V_{RFF}/\Delta I_{Z}$	Reference voltage change with cathode	IZ,min > IZ > I IIIA	Full range			2			2	V mV μA mV mV/V
Δv _{REF} /ΔiZ	current change	1 mA < I _Z < 12 mA	25°C		2	4		2	4	1111
	-	1 IIIA < 1 <u>7</u> < 12 IIIA	Full range			6			6	
	Reference voltage		25°C		-1.55	-2		-1.55	-2	
$\Delta V_{REF}/\Delta V_{KA}$	change with output voltage change	I _Z = 1 mA	Full range			-2.5			-2.5	mV/V
1	Feedback current		25°C		60	100		60	100	nΛ
I _{FB}	r eedback current		Full range			120			120	
		$I_Z = 10 \text{ mA}, V_Z = 5 \text{ V}$	25°C		±20			±20		
αV _{REF}	Average temperature coefficient of	$I_7 = 1 \text{ mA}, V_7 = 5 \text{ V}$	25°C		±15			±15		nnm/°C
U V REF	reference voltage ⁽¹⁾	12 - 1 1117, V2 - 5 V	Full range			±100			±100	ррпі, С
		$I_Z = 100 \mu A, V_Z = 5 V$	25°C		±15			±15		
7	Reverse dynamic	$I_Z = 1 \text{ mA, } f = 120 \text{ Hz,}$ $I_{AC} = 0.1 I_Z, V_Z = V_{REF}$	25°C		0.3			0.3		
Z _Z	impedance	I _Z = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _Z , V _Z = 10 V	25°C		2			2		1 12
e _N	Wideband noise	$I_Z = 100 \mu A, V_Z = V_{REF},$ 10 Hz \le f \le 10 kHz	25°C		20			20		μV _{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T _A = 25°C ± 0.1°C, I _Z = 100 μA	25°C		120			120		ppm

⁽¹⁾ Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.

11 LM4041xI (Adjustable Version) Electrical Characteristics

full-range $T_A = -40$ °C to 85°C (unless otherwise noted)

	DADAMETED	TEST CONDITIONS	т.	LI	M4041DI		LINUT	
	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT	
V _{REF}	Reference voltage	I _Z = 100 μA, V _Z = 5 V	25°C		1.233		V	
	Deference veltage telegones(1)	I = 100 \ / = 5 \/	25°C	-12		12	mV	
	Reference voltage tolerance ⁽¹⁾	$I_Z = 100 \mu A, V_Z = 5 V$	Full range	-24		24	IIIV	
	Mississons		25°C		45	75		
$I_{Z,min}$	Minimum cathode current		Full range			80	μA	
		1 - 1 - 1 mA	25°C		0.7	24 75 80 2 2.5 6 8 -2 -3 150 200		
۸۱/ /۸۱	Reference voltage change	$I_{Z,min} < I_Z < 1 \text{ mA}$	Full range			2.5	m\/	
$\Delta V_{REF}/\Delta I_{Z}$	with cathode current change	1 m A < 1 < 12 m A	25°C	2.5 mV 2 6 8 -1.55 -2 mV/V 60 150 nA		IIIV		
		1 mA < I _Z < 12 mA	Full range			8		
$\Delta V_{REF}/\Delta V_{KA}$	Reference voltage change	I _Z = 1 mA	25°C		-1.55	-2	m\//\/	
Z v KEE, \(\Omega\) KA	with output voltage change	IZ - I IIIA	Full range			-3	IIIV/V	
1	Feedback current	25°C		60	150	nΛ		
I _{FB}	r eedback current		Full range			200	ША	
		I _Z = 10 mA, V _Z = 5 V	25°C		±20			
α\/	Average temperature coefficient	$I_Z = 1 \text{ mA}, V_Z = 5 \text{ V}$	25°C		±15		ppm/°C	
αV_{REF}	of reference voltage ⁽¹⁾	12 - 1 111A, VZ - 3 V	Full range			±20 ±15		
		$I_Z = 100 \mu A, V_Z = 5 V$	25°C		±15			
Z_Z	Reverse dynamic impedance	I _Z = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _Z , V _Z = V _{REF}	25°C		0.3		Ω	
~ Z	Neverse dynamic impedance	I _Z = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _Z , V _Z = 10 V	25°C		2		12	
e _N	Wideband noise	$I_Z = 100 \mu A, V_Z = V_{REF},$ 10 Hz \le f \le 10 kHz	25°C		20		μV _{RMS}	
	Long-term stability of reverse breakdown voltage	t = 1000 h, T _A = 25°C ± 0.1°C, I _Z = 100 µA	25°C		120		ppm	

⁽¹⁾ Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.



12 LM4041xQ (Adjustable Version) Electrical Characteristics

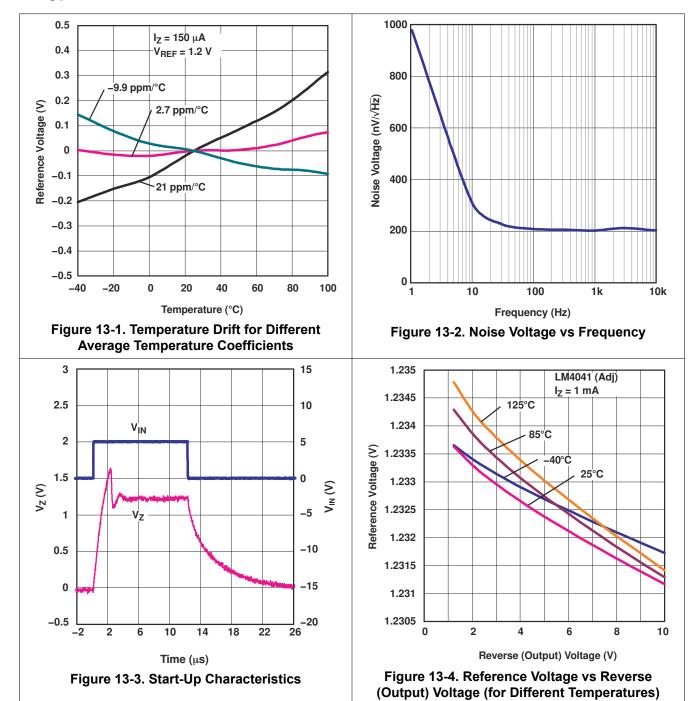
full-range $T_A = -40$ °C to 125°C (unless otherwise noted)

_	ADAMETED	TEST CONDITIONS	_	LN	//4041CQ		LN	//4041DQ		UNIT
Р.	ARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	MIN	TYP	MAX	UNII
V _{REF}	Reference voltage	I _Z = 100 μA, V _Z = 5 V	25°C		1.233			1.233		V
	Reference voltage	I ₇ = 100 μA, V ₇ = 5 V	25°C	-6.2		6.2	-12		12	mV
	tolerance ⁽¹⁾	$I_Z = 100 \mu A, V_Z = 3 V$	Full range	-18		18	-30		30	IIIV
1	Minimum cathode		25°C		45	75		45	75	
$I_{Z,min}$	current		Full range			80			80	μA
		I _{Z,min} < I _Z < 1 mA	25°C		0.7	1.5		0.7	2	
۸۱/ /۸۱	Reference voltage change with cathode	IZ,min \ IZ \ I IIIA	Full range			2			2.5	mV
$\Delta V_{REF}/\Delta I_{Z}$	current change	1 m 1 < 1 < 10 m 1	25°C		2	4		2	6	IIIV
	-	1 mA < I _Z < 12 mA	Full range			8			10	
	Reference voltage		25°C		-1.55	-2		-1.55	-2.5	
ΔV _{REF} /ΔV _{KA}	change with output voltage change	I _Z = 1 mA	Full range			-3			-4	mV/V
	Feedback current		25°C		60	100		60	150	nA
I _{FB}	reedback current		Full range			120			200	IIA
		$I_Z = 10 \text{ mA}, V_Z = 5 \text{ V}$	25°C		±20			±20		
αV_{REF}	Average temperature coefficient of	$I_7 = 1 \text{ mA}, V_7 = 5 \text{ V}$	25°C		±15			±15		ppm/°C
C V REF	reference voltage ⁽¹⁾	12 - 1 1117, V2 - 5 V	Full range			±100			±150	рріп/ С
		$I_Z = 100 \mu A, V_Z = 5 V$	25°C		±15			±15		
7	Reverse dynamic	$I_Z = 1 \text{ mA, f} = 120 \text{ Hz,}$ $I_{AC} = 0.1 I_Z, V_Z = V_{REF}$	25°C		0.3			0.3		Ω
Z_Z	impedance	I _Z = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _Z , V _Z = 10 V	25°C		2			2		1 12
e _N	Wideband noise	$I_Z = 100 \mu A, V_Z = V_{REF},$ 10 Hz \le f \le 10 kHz	25°C		20			20		μV _{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T _A = 25°C ± 0.1°C, I _Z = 100 μA	25°C		120			120		ppm

⁽¹⁾ Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.

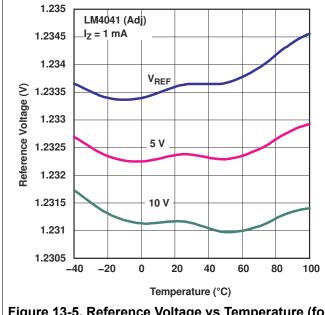


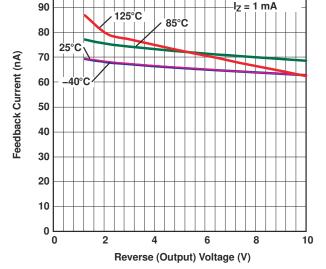
13 Typical Characteristics





LM4041 (Adj)

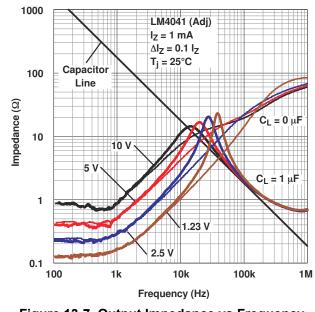




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Figure 13-5. Reference Voltage vs Temperature (for Different Reverse Voltages)

Figure 13-6. Feedback Current vs Reverse (Output) Voltage (for Different Temperatures)



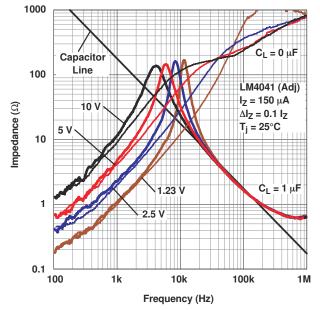
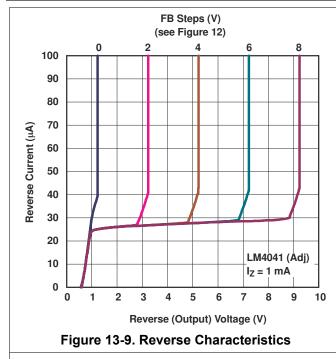


Figure 13-7. Output Impedance vs Frequency

Figure 13-8. Output Impedance vs Frequency



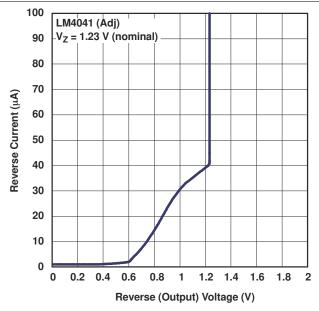


Figure 13-10. Reverse Characteristics and Minumum Operating Current

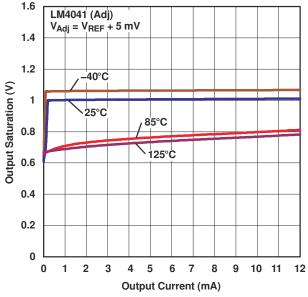


Figure 13-11. Output Saturation vs Output Current



14 Application Information

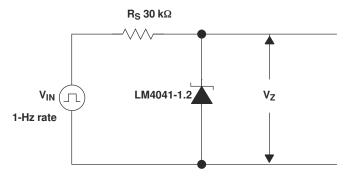


Figure 14-1. Startup Characteristics Test Circuit

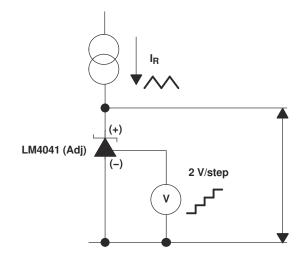


Figure 14-2. Reverse Characteristics Test Circuit

14.1 Output Capacitor

The LM4041 does not require an output capacitor across CATHODE and ANODE for stability. However, if an output bypass capacitor is desired, the LM4041 is designed to be stable with all capacitive loads.

14.2 SOT-23 and SC-70 Pin Connections

There is a parasitic Schottky diode connected between pins 2 and 3 of the SOT-23 packaged device. Thus, pin 3 of the SOT-23 package must be left floating or connected to pin 2. Similarly, pin 2 of the SC-70 package also must be left floating or connected to pin 1.

Submit Document Feedback

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14.3 Adjustable Version

The adjustable version allows V_Z to be set by a user-defined resistor divider. The output voltage, V_Z , is set according to the equation shown in Figure 14-3.

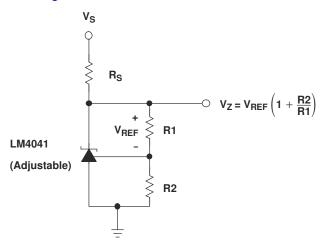


Figure 14-3. Adjustable Shunt Regulator

14.4 Cathode and Load Currents

In a typical shunt regulator configuration (see Figure 14-4), an external resistor, R_S , is connected between the supply and the cathode of the LM4041. R_S must be set properly, as it sets the total current available to supply the load (I_L) and bias the LM4041 (I_Z). In all cases, I_Z must stay within a specified range for proper operation of the reference. Taking into consideration one extreme in the variation of the load and supply voltage (maximum I_L and minimum V_S), R_S must be small enough to supply the minimum I_Z required for operation of the regulator, as given by data sheet parameters. At the other extreme, maximum V_S and minimum I_L , R_S must be large enough to limit I_Z to less than its maximum recommended rating of 12 mA.

R_S is calculated as shown in Equation 1.

$$R_{S} = \frac{(V_{S} - V_{Z})}{(I_{L} + I_{Z})}$$

$$R_{S} \geqslant V_{S}$$

$$V_{Z} \downarrow I_{Z} + I_{L}$$

$$V_{Z} \downarrow I_{Z}$$

$$LM4041 \downarrow I_{Z}$$

$$LM4041 \downarrow I_{Z}$$

$$(1)$$

Figure 14-4. Shunt Regulator



15 Revision HistoryNOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	hanges from Revision E (February 2006) to Revision F (September 2020)	Page
•	Updated the numbering format for tables, figures and cross-references throughout the document	1
•	Deleted Ordering Information table. See Mechanical, Packaging, and Orderable Information at the end data sheet	



16 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



www.ti.com 8-Feb-2022

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM4041A12IDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)	Samples
LM4041A12IDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)	Samples
LM4041A12IDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)	Samples
LM4041A12IDCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MKU	Samples
LM4041B12IDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)	Samples
LM4041B12IDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)	Samples
LM4041B12IDCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MLU	Samples
LM4041BIDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)	Samples
LM4041BIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)	Samples
LM4041BIDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)	Samples
LM4041BIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)	Samples
LM4041BIDCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU	Samples
LM4041BIDCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU	Samples
LM4041C12IDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)	Samples
LM4041C12IDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)	Samples
LM4041C12IDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)	Samples
LM4041C12IDBZTG4	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)	Samples
LM4041C12IDCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MMU	Samples
LM4041C12IDCKRE4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MMU	Samples
LM4041C12IDCKRG4	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MMU	Samples





8-Feb-2022 www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM4041C12ILP	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	NPC12I	Samples
LM4041C12ILPR	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	NPC12I	Samples
LM4041C12QDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)	Samples
LM4041C12QDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)	Samples
LM4041C12QDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)	Samples
LM4041CIDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)	Samples
LM4041CIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)	Samples
LM4041CIDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)	Samples
LM4041CIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)	Samples
LM4041CIDCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU	Samples
LM4041CIDCKT	ACTIVE	SC70	DCK	5	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU	Samples
LM4041CILP	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	NPCI	Samples
LM4041CILPE3	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	NPCI	Samples
LM4041CILPR	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	NPCI	Samples
LM4041CQDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)	Samples
LM4041CQDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)	Samples
LM4041CQDBZTG4	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)	Samples
LM4041D12IDBZR	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)	Samples
LM4041D12IDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)	Samples
LM4041D12IDBZT	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)	Samples
LM4041D12IDBZTG4	ACTIVE	SOT-23	DBZ	3	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)	Samples



8-Feb-2022



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Orderable Device Package Type Package Pins Package Eco Plan Lead finish/ **MSL Peak Temp** Op Temp (°C) **Device Marking** Status Samples Drawing Qty **Ball material** (1) (2) (3) (4/5)(6) LM4041D12IDCKR **ACTIVE** SC70 **DCK** 5 3000 RoHS & Green **NIPDAU** Level-1-260C-UNLIM -40 to 85 MNU Samples LM4041D12ILP **ACTIVE** TO-92 LP 3 1000 RoHS & Green SN N / A for Pkg Type -40 to 85 NPD12I Samples LM4041D12ILPE3 LP N / A for Pkg Type **ACTIVE** TO-92 3 1000 RoHS & Green SN -40 to 85 NPD12I Samples **ACTIVE** TO-92 LP 3 2000 RoHS & Green SN NPD12I LM4041D12ILPR N / A for Pkg Type -40 to 85 Samples **NIPDAU** LM4041D12QDBZR **ACTIVE** SOT-23 DBZ 3 3000 RoHS & Green Level-1-260C-UNLIM -40 to 125 (4MT3, 4MTU) Samples LM4041DIDBZR **ACTIVE** SOT-23 DBZ 3 3000 RoHS & Green **NIPDAU** Level-1-260C-UNLIM -40 to 85 (4MJ3, 4MJU) Samples LM4041DIDBZRG4 **ACTIVE** SOT-23 DBZ 3 3000 RoHS & Green **NIPDAU** Level-1-260C-UNLIM -40 to 85 (4MJ3, 4MJU) Samples LM4041DIDBZT **ACTIVE** SOT-23 DBZ 3 250 RoHS & Green **NIPDAU** Level-1-260C-UNLIM -40 to 85 (4MJ3, 4MJU) Samples LM4041DIDBZTG4 ACTIVE SOT-23 DB7 3 250 RoHS & Green **NIPDAU** Level-1-260C-UNLIM (4MJ3, 4MJU) -40 to 85 Samples LM4041DIDCKR **ACTIVE** SC70 DCK 5 3000 RoHS & Green **NIPDAU** Level-1-260C-UNLIM MJU -40 to 85 Samples **ACTIVE** SC70 5 **NIPDAU** LM4041DIDCKT **DCK** 250 RoHS & Green Level-1-260C-UNLIM -40 to 85 MJU Samples LM4041DILP **ACTIVE** TO-92 LP 3 1000 RoHS & Green SN N / A for Pkg Type -40 to 85 **NPDI** Samples LM4041DILPR **ACTIVE** TO-92 LP 3 2000 RoHS & Green SN NPDI N / A for Pkg Type -40 to 85 Samples LM4041DQDBZR **ACTIVE** SOT-23 DBZ 3 RoHS & Green **NIPDAU** (4MR3, 4MRU) 3000 Level-1-260C-UNLIM -40 to 125 Samples

NIPDAU

NIPDAU

NIPDAU

Level-1-260C-UNLIM

Level-1-260C-UNLIM

Level-1-260C-UNLIM

-40 to 125

-40 to 125

-40 to 125

(4MR3, 4MRU)

(4MR3, 4MRU)

(4MR3, 4MRU)

Samples

Samples

Samples

LM4041DQDBZRG4

LM4041DQDBZT

LM4041DQDBZTG4

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

SOT-23

SOT-23

SOT-23

DBZ

DBZ

DBZ

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

3

3

3

3000

250

250

RoHS & Green

RoHS & Green

RoHS & Green

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

ACTIVE

ACTIVE

ACTIVE

⁽¹⁾ The marketing status values are defined as follows:



PACKAGE OPTION ADDENDUM

www.ti.com 8-Feb-2022

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2021

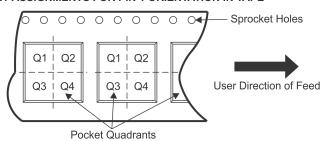
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4041A12IDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041A12IDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041A12IDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041A12IDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041A12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041B12IDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041B12IDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041B12IDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041B12IDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041B12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041BIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041BIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041BIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041BIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041BIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041BIDCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041C12IDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041C12IDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3



PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2021

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4041C12IDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041C12IDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041C12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041C12QDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041C12QDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041C12QDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041C12QDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041CIDCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041CQDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CQDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CQDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CQDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041D12IDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041D12IDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041D12IDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041D12IDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041D12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041D12QDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041D12QDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041DIDCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041DQDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DQDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DQDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DQDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3



www.ti.com 5-Jan-2021



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4041A12IDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041A12IDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041A12IDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041A12IDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041A12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041B12IDBZR	SOT-23	DBZ	3	3000	203.0	203.0	35.0
LM4041B12IDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041B12IDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041B12IDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041B12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041BIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041BIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041BIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041BIDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041BIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041BIDCKT	SC70	DCK	5	250	203.0	203.0	35.0
LM4041C12IDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041C12IDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041C12IDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041C12IDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0



PACKAGE MATERIALS INFORMATION

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4041C12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041C12QDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041C12QDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041C12QDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041C12QDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041CIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041CIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041CIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041CIDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041CIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041CIDCKT	SC70	DCK	5	250	200.0	183.0	25.0
LM4041CQDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041CQDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041CQDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041CQDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041D12IDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041D12IDBZR	SOT-23	DBZ	3	3000	203.0	203.0	35.0
LM4041D12IDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041D12IDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041D12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041D12QDBZR	SOT-23	DBZ	3	3000	203.0	203.0	35.0
LM4041D12QDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041DIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041DIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041DIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041DIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041DIDCKT	SC70	DCK	5	250	200.0	183.0	25.0
LM4041DQDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041DQDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041DQDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041DQDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040001-2/F



TO-92 - 5.34 mm max height

TO-92



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.
- 3. Lead dimensions are not controlled within this area.4. Reference JEDEC TO-226, variation AA.
- 5. Shipping method:

 - a. Straight lead option available in bulk pack only.
 b. Formed lead option available in tape and reel or ammo pack.
 - c. Specific products can be offered in limited combinations of shipping medium and lead options.
 - d. Consult product folder for more information on available options.



TO-92





TO-92





DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.





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4203227/C





SMALL OUTLINE TRANSISTOR



NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC registration TO-236, except minimum foot length.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 7. Board assembly site may have different recommendations for stencil design.



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